

## Features

- Fast Switching Speed: max. 50 ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: 100nA at room temperature
- Ultra Small Plastic SMD Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 5)**

## Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish - Matte Tin Annealed over Alloy 42 Leadframe.
- Solderable per MIL-STD-202, Method 208 
- Weight: 0.0014 grams (Approximate)

SOD523



Top View



Device Schematic

## Ordering Information (Note 4)

| Part Number | Compliance | Case   | Packaging (Note 6) |
|-------------|------------|--------|--------------------|
| BAS521Q-13  | Automotive | SOD523 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
  5. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to [http://www.diodes.com/quality/product\\_compliance\\_definitions/](http://www.diodes.com/quality/product_compliance_definitions/).
  6. Dispensed in every other cavity of the tape.

## Marking Information



99 = Product Type Marking Code  
Bar Denotes Cathode Side

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

| Characteristic                                                   | Symbol    | Value | Unit |
|------------------------------------------------------------------|-----------|-------|------|
| Repetitive Peak Reverse Voltage                                  | $V_{RRM}$ | 300   | V    |
| Working Peak Reverse Voltage                                     | $V_{RWM}$ | 300   | V    |
| DC Blocking Voltage                                              |           |       |      |
| Forward Current (Note 7)                                         | $I_F$     | 250   | mA   |
| Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$ | $I_{FSM}$ | 4.5   | A    |
| Repetitive Peak Forward Current (Note 7)                         | $I_{FRM}$ | 1     | A    |

**Thermal Characteristics**

| Characteristic                                      | Symbol          | Value       | Unit               |
|-----------------------------------------------------|-----------------|-------------|--------------------|
| Power Dissipation (Note 7)                          | $P_D$           | 325         | mW                 |
| Thermal Resistance Junction to Ambient Air (Note 7) | $R_{\theta JA}$ | 385         | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range             | $T_J, T_{STG}$  | -65 to +150 | $^\circ\text{C}$   |

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

| Characteristic                     | Symbol      | Min | Max | Unit          | Test Condition                                                      |
|------------------------------------|-------------|-----|-----|---------------|---------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 8) | $V_{(BR)R}$ | 300 | —   | V             | $I_R = 100\mu\text{A}$                                              |
| Forward Voltage                    | $V_F$       | —   | 1.1 | V             | $I_F = 100\text{mA}$                                                |
| Reverse Current (Note 8)           | $I_R$       | —   | 50  | nA            | $V_R = 5\text{V}$                                                   |
|                                    |             | —   | 150 | nA            | $V_R = 250\text{V}$                                                 |
|                                    |             | —   | 100 | $\mu\text{A}$ | $V_R = 250\text{V}, T_J = +150^\circ\text{C}$                       |
| Total Capacitance                  | $C_T$       | —   | 5   | pF            | $V_R = 0, f = 1.0\text{MHz}$                                        |
| Reverse Recovery Time              | $t_{rr}$    | —   | 50  | ns            | $I_F = I_R = 30\text{mA}, I_{rr} = 0.1 \times I_R, R_L = 100\Omega$ |

Notes: 7. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.  
 8. Short duration pulse test used to minimize self-heating effect.

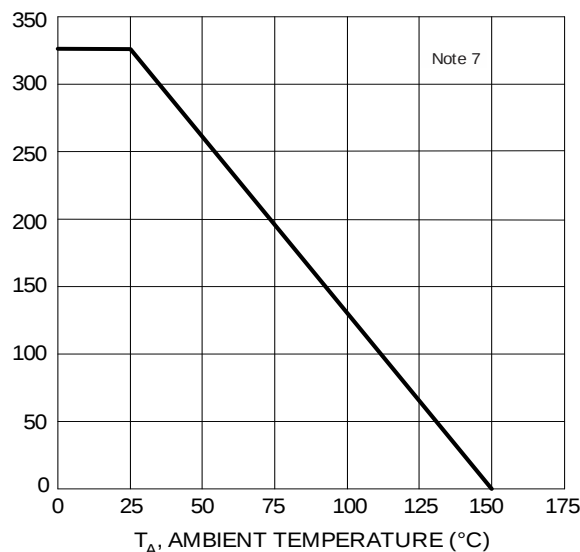


Figure 1 Power Derating Curve, Total Package

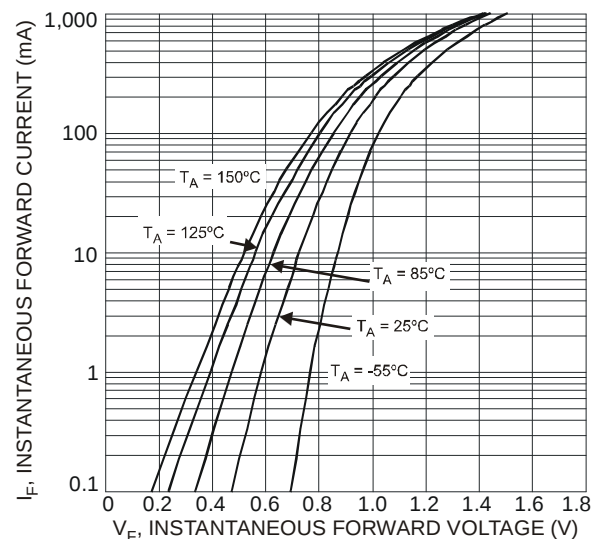


Fig. 2 Typical Forward Characteristics, Per Element

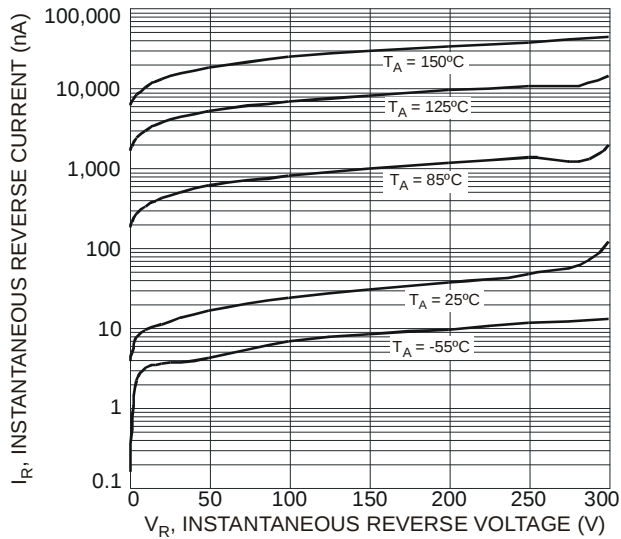


Fig. 3 Typical Reverse Characteristics, Per Element

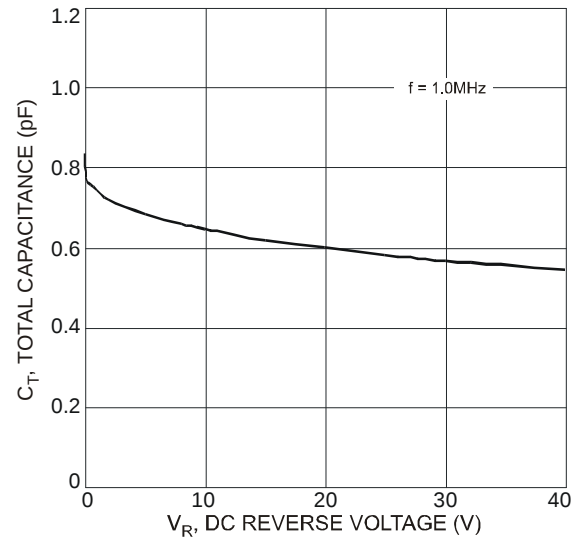
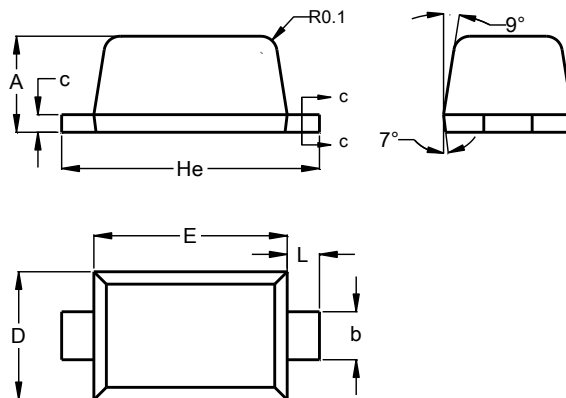


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

## Package Outline Dimensions

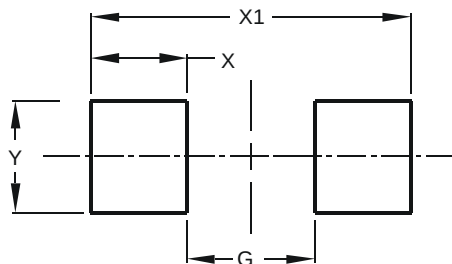
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| SOD523               |      |      |
|----------------------|------|------|
| Dim                  | Min  | Max  |
| A                    | 0.55 | 0.65 |
| b                    | 0.26 | 0.34 |
| c                    | 0.11 | 0.17 |
| D                    | 0.75 | 0.85 |
| E                    | 1.15 | 1.25 |
| He                   | 1.55 | 1.65 |
| L                    | 0.10 | 0.30 |
| All Dimensions in mm |      |      |

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G          | 0.80          |
| X          | 0.60          |
| X1         | 2.00          |
| Y          | 0.70          |

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